Panasonic

INDUSTRY

OS-CON

Conductive Polymer Aluminum Solid Capacitors

Radial Lead Type

SEP series

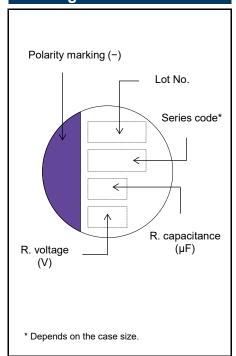


Features

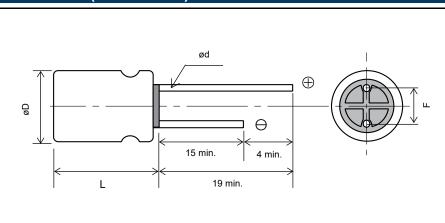
- Standard
- 105 °C 3000 h
- RoHS compliance, Halogen free

Specifications								
Size code	C6		E7	E12	F8	F13		
Category temp. range				–55 ℃ to +105 ℃		•		
Rated voltage range	4.0 V t	to 20 V		2.5 V to 20 V	4.0 V to 20 V	2.5 V to 20 V		
Nominal cap.range	22 μF to 150 μF	33 µF	to 330 µF	100 μF to 680 μF	56 μF to 680 μF	150 μF to 1500 μF		
Capacitance tolerance	±20 % (120 Hz / +20 ℃)							
DC leakage current	Please see the attached characteristics list							
Dissipation factor (tan δ)	Please see the attached characteristics list							
	+105 ℃ 3000 h, rated voltage applied (2.5 V products : 2000 h)							
Endurance	Capacitance change Within ±		Within ±20	in ±20 % of the initial value				
Endurance	Dissipation factor (tanδ) ≤ 150 % of the initial limit							
	DC leakage curi	ent	t Within the initial limit					
	+60 ℃, 90 % to 95 % RH, 1000 h, No-applied voltage							
Damp heat	Capacitance cha	inge	Within ±20	% of the initial value		_		
(Steady state)	Dissipation factor	(tanδ)	≦ 150 % of	the initial limit				
	DC leakage curi	ent	Within the initial limit (after voltage processing)					

Marking



Dimensions (not to scale)



Unit: mm

Size code	øD±0.5	L max.	F±0.5	ød±0.05
C6	6.3	6.0	2.5	0.45
E7	8.0	7.0	3.5	0.45
E12	8.0	12.0	3.5	0.6
F8	10.0	8.0	5.0	0.5
F13	10.0	13.0	5.0	0.6

Characteristics list Case size Specifications Part number Rated (mm) Rated capacitance Size Ripple voltage Click here for part number ESR*2 LC*4 (±20 %) code øD tan δ^{*3} (V) L current *1 list of lead terminal cutting (µF) (mΩ max.) (µA) (mA rms) and lead terminal taping 4520 2R5SEP680M 680 8.0 12.0 E12 13 0.15 340 2.5 13.0 F13 1500 10.0 5440 12 0.18 750 2R5SEP1500M 6.0 100 6.3 1810 40 0.12 200 4SEP100M C6 150 6.3 6.0 1810 40 0.12 300 4SEP150M 220 8.0 7.0 2560 35 0.12 440 4SEP220M E7 7.0 2560 660 330 8.0 35 0.12 4SEP330M 4.0 F8 3700 25 0.12 376 470 10.0 8.0 4SEP470M 560 8.0 12.0 E12 4520 13 0.15 448 4SEP560M 4SEP680M 10.0 8.0 F8 3700 25 544 680 0.12 1200 10.0 13.0 F13 5440 12 960 4SEP1200M 0.18 6.0 1700 45 0.12 258 6SEP82M 82 6.3 C6 150 8.0 7.0 E7 2560 35 0.12 472 6SEP150M 6.3 330 10.0 8.0 F8 3700 25 0.12 416 6SEP330M 12.0 470 8.0 E12 4210 15 0.15 592 6SEP470M 820 10.0 13.0 F13 5440 12 0.15 775 6SEP820M 6.3 6.0 C6 1700 45 0.12 280 56 10SEP56M 35 600 10SEP120M 120 8.0 7.0 E7 2560 0.12 270 10.0 8.0 F8 3700 25 540 10SEP270M 10 0.12 330 8.0 12.0 E12 3950 17 0.15 660 10SEP330M 560 10.0 13.0 F13 5230 13 0.15 840 10SEP560M 39 6.3 6.0 C6 1620 50 0.10 312 16SEP39M 82 8.0 7.0 **E7** 2120 40 0.12 656 16SEP82M F8 480 16 150 10.0 8.0 3020 30 0.12 16SEP150M 8.0 12.0 E12 3640 20 576 16SEP180M 180 0.15 4720 792 16SEP330M 330 10.0 13.0 F13 16 0.15 22 6.3 6.0 C6 1450 60 0.10 220 20SEP22M 7.0 1890 330 20SEP33M 33 8.0 45 0.12 E7 47 8.0 7.0 1890 45 0.12 470 20SEP47M 56 10.0 8.0 2400 40 0.12 224 20SEP56M 20 2400 40 272 20SEP68M 68 10.0 8.0 F8 0.12 10.0 8.0 2570 0.12 400 20SEP100MX 35 100 12.0 400 8.0 E12 3320 24 0.15 20SEP100M 150 10.0 13.0 F13 4320 20 0.15 600 20SEP150M

[♦] Please refer to each page in this catarog for "Flow conditions" and "Taping specifications".

Frequency correction factor for ripple current							
Frequency(f)	120 Hz ≦ f < 1 kHz	1 kHz ≦ f < 10 kHz	10 kHz ≦ f < 100 kHz	100 kHz ≤ f < 500 kHz			
Coefficient	0.05	0.3	0.7	1			

^{*1:} Ripple current (100 kHz / +105 ℃)

^{*2:} ESR (100 kHz to 300 kHz / +20 ℃)

^{*3:} tan δ (120 Hz / +20 °C)

^{*4:} After 2 minutes

Packing specifications

Lead terminal process

1-1. Correspondence list

 $\stackrel{.}{\mathbb{X}}$ The following table is a standard specification. Please contact us separately concerning specifications except for that mentioned below.

Series	Size code	Bag-packed products	Taning products	
Selles	Size code	Not processed	Straight cut	Taping products
SEP	C6, E7, E12	No code	+C3	+TSS
SEP	F8, F13	No code	+C3	+T

1-2. Lead terminal cutting specifications

Process names	Size code	Lead terminal cutting code	Lead terminal dimensions
Straight cut	C6 E7, E12 F8, F13	+C3	L Unit : mm

1-3. Taping specifications for automatic insertion

Size code	Case size	F	Taping code	Taping dimensions
C6	ø6.3	F=2.5 mm	+TSS	P ₂ P →
E7, E12	ø8	F=3.5 mm	1100	Carrier tape Hold-down tape
F8, F13	ø10	F=5.0 mm	+T	P ₁ P D D D Carrier tape

Cod	le	F	Р	P ₀	P ₁	P ₂	Δh	W	W ₀	W ₁	W ₂	Н	øD ₀
Tolera	ince	+0.8 -0.2	±1.0	±0.2	±0.5	±1.0	±1.0	±0.5	min.	±0.5	max.	±0.75	±0.2
+TSS	ø6.3	2.5	12.7	12.7	5.10	6.35	0	18.0	9.5	9.0	2.5	17.5	4.0
T133	ø8	3.5	12.7	12.7	4.60	6.35	0	18.0	9.5	9.0	2.5	17.5	4.0
+T	ø10	5.0	12.7	12.7	3.85	6.35	0	18.0	9.5	9.0	2.5	18.5	4.0

Cod	е	t	l	L
Tolera	nce	±0.3	max.	max.
+TSS	ø6.3	0.6	0	11.0
	ø8	0.6	0	11.0
+T	ø10	0.6	0	11.0

Unit: mm

Minimum packing quantity and weight

Size	Size Case Ba		ed products	Taping products	
code	size	Quantity(pcs./Bag)	Typical weight(g)	Quantity(pcs./Bag)	Typical weight(g)
C6	ø6.3	500	160	1500	700
E7	ø8	200	110	1000	820
E12	ø8	200	200	1000	980
F8	ø10	200	180	500	890
F13	ø10	200	280	500	940

Radial lead (Lea	ad terminal cutting / Lead	d terminal taping)	
Series	No processing	Lead terminal cutting	Lead terminal taping
	10SEP120M	10SEP120M+C3	10SEP120M+TSS
	10SEP270M	10SEP270M+C3	10SEP270M+T
	10SEP330M	10SEP330M+C3	10SEP330M+TSS
	10SEP560M	10SEP560M+C3	10SEP560M+T
	10SEP56M	10SEP56M+C3	10SEP56M+TSS
	16SEP150M	16SEP150M+C3	16SEP150M+T
	16SEP180M	16SEP180M+C3	16SEP180M+TSS
	16SEP330M	16SEP330M+C3	16SEP330M+T
	16SEP39M	16SEP39M+C3	16SEP39M+TSS
	16SEP82M	16SEP82M+C3	16SEP82M+TSS
	20SEP100M	20SEP100M+C3	20SEP100M+TSS
	20SEP100MX	20SEP100MX+C3	20SEP100MX+T
	20SEP150M	20SEP150M+C3	20SEP150M+T
	20SEP22M	20SEP22M+C3	20SEP22M+TSS
	20SEP33M	20SEP33M+C3	20SEP33M+TSS
	20SEP47M	20SEP47M+C3	20SEP47M+TSS
SEP	20SEP56M	20SEP56M+C3	20SEP56M+T
	20SEP68M	20SEP68M+C3	20SEP68M+T
	2R5SEP1500M	2R5SEP1500M+C3	2R5SEP1500M+T
	2R5SEP680M	2R5SEP680M+C3	2R5SEP680M+TSS
	4SEP100M	4SEP100M+C3	4SEP100M+TSS
	4SEP1200M	4SEP1200M+C3	4SEP1200M+T
	4SEP150M	4SEP150M+C3	4SEP150M+TSS
	4SEP220M	4SEP220M+C3	4SEP220M+TSS
	4SEP330M	4SEP330M+C3	4SEP330M+TSS
	4SEP470M	4SEP470M+C3	4SEP470M+T
	4SEP560M	4SEP560M+C3	4SEP560M+TSS
	4SEP680M	4SEP680M+C3	4SEP680M+T
	6SEP150M	6SEP150M+C3	6SEP150M+TSS
	6SEP330M	6SEP330M+C3	6SEP330M+T
	6SEP470M	6SEP470M+C3	6SEP470M+TSS
	6SEP820M	6SEP820M+C3	6SEP820M+T
	6SEP82M	6SEP82M+C3	6SEP82M+TSS



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- The switchover date for compliance with the RoHS Directive/REACH Regulations varies depending on the part number or series of our products.
- When you use the inventory of our products for which it is unclear whether those products are compliant with the RoHS Directive/REACH Regulation, please select "Sales Inquiry" in the website inquiry form and contact us.

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Notices

■ Applicable laws and regulations

- This product complies with the RoHS Directive (Restriction of the use of certain hazardous substances in electrical and electronic equipment (DIRECTIVE 2011/65/EU and (EU)2015/863)).
- No Ozone Depleting Chemicals(ODC's), controlled under the Montreal Protocol Agreement, are used in producing this product. We do not use PBBs or PBDEs as brominated flame retardants.
- Follow export procedures in accordance with the Foreign Exchange and Foreign Trade Law and other export-related laws and regulations when exporting this product.
- These products are not dangerous goods on the transportation as identified by UN(United Nations) numbers or UN classification.

■ Limited applications

- This capacitor is designed to be used for electronics circuits such as audio/visual equipment, home appliances, computers and other office equipment, optical equipment, measuring equipment.
- An advanced specification must be signed individually for high-reliability use that might threaten human life or property due to a malfunction of the capacitor.

■ Intellectual property rights and licenses

• The technical information in this specification provides examples of our products' typical operations and application circuits. We do not guarantee the non-infringement of third party's intellectual property rights and we do not grant any license, right, or interest in our intellectual property.

Items to be observed

■ For specification

- $\boldsymbol{\cdot} \text{ This specification guarantees the quality and performance of the product as individual components}.$
 - The durability differs depending on the environment and the conditions of usage.
 - Before use, check and evaluate their compatibility with actual conditions when installed in the products.
 - When safety requirements cannot be satisfied in your technical examination, inform us immediately.
- · Do not use the products beyond the specifications described in this document.

■ Upon application to products where safety is regarded as important

If a malfunction of this product may result in the loss of human life or other serious damage, in traffic transportation equipment (trains, automobiles, traffic signals, etc.), medical equipment, aerospace equipment, electric heating equipment, combustion and gas equipment, rotating equipment, disaster prevention and security equipment, etc., ensure safety by giving sufficient consideration to a fail-safe design, for example, by considering the following items.

- (1) The system is equipped with a protection circuit and protection device.
- (2) The system is equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault.

■ Conditions of use

- Before using the products, carefully check the effects on their quality and performance, and determined whether or not they can be used. These products are designed and manufactured for general-purpose and standard use in general electronic equipment. These products are not intended for use in the following special conditions.
 - (1) In liquid, such as Water, Oil, Chemicals, or Organic solvent.
 - (2) In direct sunlight, outdoors, or in dust.
 - (3) In vapor, such as dew condensation water of resistive element, or water leakage, salty air, or air with a high concentration corrosive gas, such as Cl₂, H₂S, NH₃, SO₂, or NOx.
 - (4) In an environment where strong static electricity or electromagnetic waves exist.
 - (5) Mounting or placing heat-generating components or inflammables, such as vinyl-coated wires, near these products.
 - (6) Sealing or coating of these products or a printed circuit board on which these products are mounted, with resin and other material.
 - (7) Using resolvent, water or water-soluble cleaner for flux cleaning agent after soldering. (In particular, when using water or a water-soluble cleaning agent, be careful not to leave water residues)
 - (8) Using in the atmosphere where strays acid or alkaline.
 - (9) Using in the atmosphere where there are excessive vibration and shock.
 - (10) Using in the atmosphere where there are low pressure or decompression.
- Please arrange circuit design for preventing impulse or transitional voltage.

 Ensure that the voltage is lower than the rated voltage in the following condition: shock voltage circuits, transient phenomena in which excessive high voltage is applied in a short period of time, or when pulse high voltage is applied.
- Our products there is a product are using an electrolyte solution. Therefore, misuse can result in rapid deterioration of characteristics and functions of each product. Electrolyte leakage damages printed circuit and affects performance, characteristics, and functions of customer system.





Application Guidelines (OS-CON)

1. Circuit design

1.1 Prohibited circuits

- (1) Leakage current of the OS-CON may increase in the following conditions.
 - (a) Soldering
 - (b) When voltage is not applied: high temperature no-load test, high temperature and high humiditynoload test, rapidly changing temperature test, etc.
- (2) Avoid the use of the OS-CON in the following type of circuits because leakage current may increase.
 - (a) High-impedance circuits
 - (b) Coupling circuits
 - (c) Time constant circuits
 - (d) Other circuits that are significantly affected by leakage current.
 - * If you plan to use 2 or more OS-CONs in a series connection, please contact us before use.

1.2 Failure and life-span

The failure rate is 0.5 % /1000 h (Confidence level : 60 %) based on JIS C 5003.

The prospective failure is not zero. The mainly failure modes are as follows.

1.2-1 Contingency failure

The most common failure mode is a short circuit. Mainly caused by the soldering or operating temperature environment, along with heat stresses, electrical stresses or mechanical stressesas follows.

- · Applying voltage over the rated voltage.
- · Applying reverse voltage
- · Excessive mechanical stress
- · Applying rush current by sudden charge or discharge out of the specification.
- (1) The following phenomenon is seen when short-current is applied to the OS-CON.
 - (a) When current is relatively low. (ø10 : approx 1 A or less, ø8 : approx 0.5 A or less, ø6.3 : approx 0.2 A or less)

 The OS-CON becomes heated, but no effects are visible even when the current is continuously carried.
 - (b) When the short circuit currents exceed the mentioned value above.
 - After internal temperature increase, sealing rubber may be turned over.
 - In some cases, odorous gas may be produced.
- (2) In case a short circuit occurs, ensure safety by fully considering the followings.
 - (a) If odorous gas is released, turn off the main power of the equipment.
 - In this case, keep your face and hands away from the area.
 - (b) It may take a few seconds to a few minutes for odor gas to be generated depending on the conditions. When using a protective circuit, design the product so that it operates during this period.
 - (c) If the gas comes into eyes, rinse immediately. If the gas is inhaled, gargle immediately.
 - (d) Do not lick the electrolyte. If the electrolyte touches skin, wash it off with soap immediately.
 - (e) OS-CON contains combustibles. The short-circuit part may spark and catch fire if the current value after a short-circuit is extremely large. Provide for safety designs such as redundant design and protection circuit.

1.2-2 Wear-out failure (life time)

When lifetime span exceeded the specified guarantee time of endurance and damp heat, electrolyte might insulate and cause electric characteristic changed. This is called an open circuit.

The electric characteristics of capacitance and ESR may possibly change within the specified range in specifications even if it is used under the condition of the rated voltage, electric and mechanical performance.

Please note it when designing.

1.3 Leakage current

Mechanical stress may cause OS-CON's leakage current increased.

In such a case, leakage current will gradually decrease by applying voltage (withinthe category voltage and the upper limit of category temperature).

1.4 Rapid charge and discharge limitation

Allowance of a large rush current to flow due to rapid charge and discharge may result in short circuit or large leakage current. The protection circuit, to maintain high reliability, is recommended when rush current to flow to the OS-CON is in the following cases.

- (1) Products which 10 times of allowable ripple current is less than 10 A: It is when 10 A or over of rush current is applied.
- (2) Products which 10 times of allowable ripple current is 10 A or over: It is when rush current, which the figure is over 10 times of allowable ripple current, is applied.



2. Mounting

2.1 Soldering with a soldering iron

- (1) When lead terminals for radial lead type must be processed because the lead pitch and the PCB holes do not match, process them without any stresses to the OS-CON before soldering.
- (2) Solder without any excessive stresses to the OS-CON itself.
- (3) When the OS-CON has been soldered once and needs to be removed, remove it after the solder has been completely melted.
- (4) Do not let the tip of the soldering iron touch the OS-CON itself.

2.2 Flow soldering

- (1) Do not apply flow soldering to OS-CON SMD type.
- (2) Do not solder the OS-CON itself by submerging it in melted solder.
- (3) Solder the opposite side that the OS-CON is mounted on.
- (4) Note that flux does not adhere to anywhere expect the lead terminal.
- (5) Note that other components do not fall over and touch the OS-CON when soldering.

2.3 Reflow soldering

- (1) Do not apply reflow soldering to OS-CON Radial Lead type.
- (2) Please contact us for setting VPS conditions.

2.4 Capacitor handling after soldering

Do not subject the OS-CON to excessive stress as follows.

- (1) Do not tilt, bend or twist the OS-CON.
- (2) Do not move the PCB with holding the OS-CON itself.
- (3) Do not hit the OS-CON with objects.
- (4) When stacking PCBs, make sure that the OS-CON does not touch other PCBs or components.

2.5 Circuit board cleaning

Check the following items before washing PC board with these detergents: high quality alcohol-based cleaning fluid such as Pine-a ST-100S, clean thru 750H, 750L, 710M, 750K or Techno Care FRW 14 through 17 or detergents including substitute freon as AK-225AES or IPA.

- (1) Use immersion or ultrasonic waves to clean within 2 minutes.
- (2) The temperature of the cleaning fluid should be less than 60 °C.
- (3) Watch the contamination of the detergent such as conductivity, pH, specific gravity, water content, etc.
- (4) Do not store the OS-CON in a location subject to gases from the cleaning fluid or in an airtight container after cleaning.
- (5) Dry the PCB or OS-CON with hot air that should be less than the upper category temperature.
- (6) Please note that indication may disappear when rubbing print side after washing depending on a cleaner.
- (7) Please contact us for details about detergents, cleaning methods and detergents other than those listed above.

2.6 Fixatives and coating materials

- (1) Select the appropriate covering and sealant materials for the OS-CON. In particular, don't use acetone in the fixative, coating agent and diluent.
- (2) Before applying the fixative or coating, completely remove any flux residue and foreign matter from the area where the board and the OS-CON will be jointed together.
- (3) Allow any detergent to dry before applying the fixative or coating.
- (4) Please contact us for the fixative and coating heat curing conditions.

2.7 Capacitor insulation

Be sure to completely separate the case, negative lead terminal, positive lead terminal and PC board patterns with each other due to the following reasons.

- (1) Insulation is not guaranteed at a part of resin on the surface of a case.
- (2) It offers inconstant resistance between a case and a negative lead terminal and it isn't insulated.



3. Storage

Open the bags just before mounting and use up all products once opened, For keeping a good solderability, store the OS-CON as follows.

		Before unsealing	After unsealing	
SMD type ^{*1}		Within 24 months after shipment	Within 30 days from opening (packaged with carrier tape)	
Radial	Bag packing product	Within 30 months after shipment	Within 7 days from opening	
lead type	Taping product	Within 24 months after shipment	within 7 days from opening	

^{*1 :} The JEDEC J-STD-020 standard is not applicable

* Intellectual property right

We, Panasonic Group are providing the product and service that customers can use without anxiety, and are working positively on the protection of our products underintellectual property rights.

Representative patents relating to OS-CON are as follows:

US Patent No.7158367